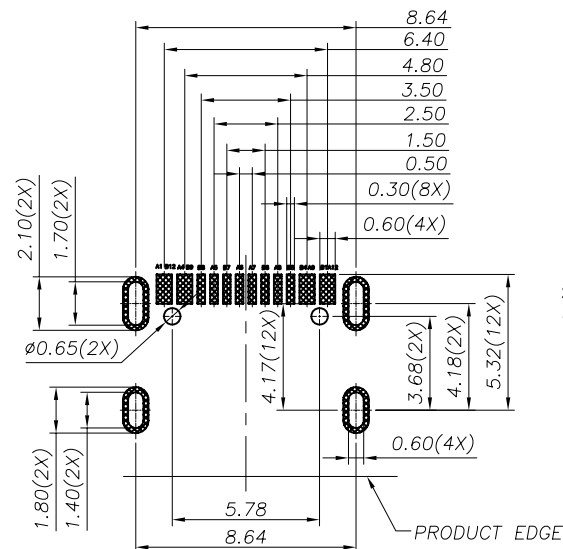
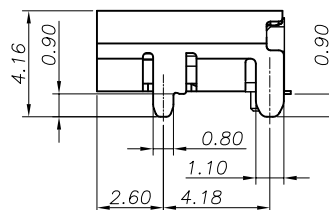
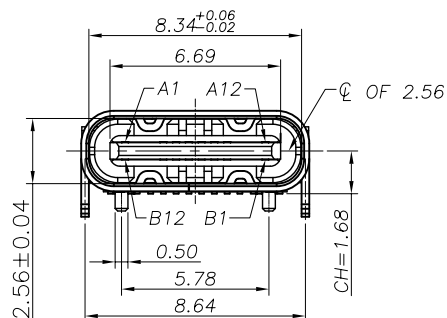
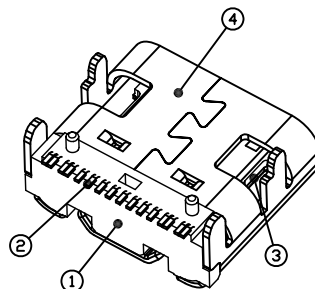




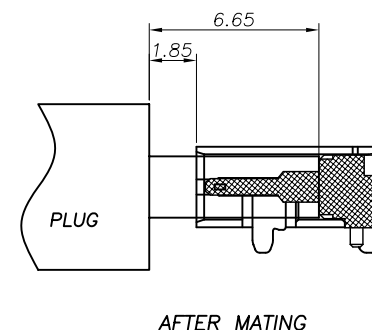
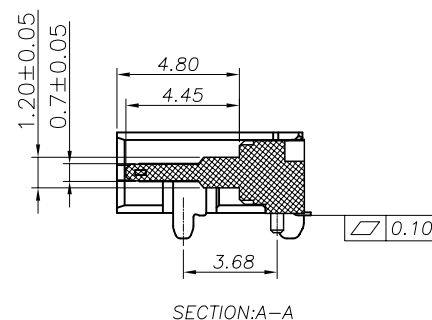
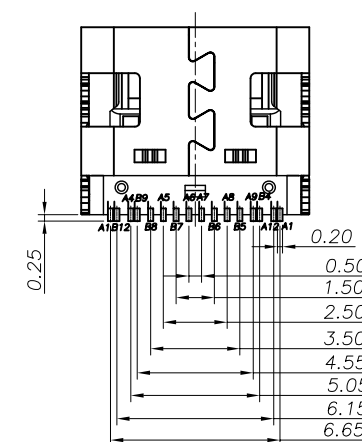
Ni 50u" MIN. UNDER PLATED OVER ALL.
Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
(GOLD PLATING THICKNESS FOLLOW THE P/N)
PLATING SPECIFICATIONS OF THE SOLDER AREA FOLLOW THE P/N

3. MECHANICAL PERFORMANCE,
 3-1. INSERTION FORCE: 0.5~2.0kgf.
 3-2. REMOVAL FORCE: 0.8kgf~2.0kgf.
 3-3. DURABILITY: 10000 CYCLES.

4. ELECTRICAL PERFORMANCE,
 4-1. CURRENT RATING: 5.0A
 VOLTAGE RATING: 5.0V
 4-2. LLCR:
 VBUS & GND PINS AND OTHER PINS: 40mΩ/PIN MAX.
 SHIELD: 50mΩ/MAX.
 LLCR MAX. CHANGE OF ALL PINS: 10mΩ.
 4-3. INSULATION RESISTANCE: 100MΩ MIN
 4-4. DIELECTRIC WITHSTAND VOLTAGE, AC 100V FOR 1 MINUTE.

5. ENVIRONMENTAL PERFORMANCE,
 OPERATING TEMPERATURE: -25℃~+85℃.

BE MAINTAINED FOR 10 SECONDS AT 260°C.



PIN NUMBER	SIGNAL NAME	PIN NUMBER	SIGNAL NAME
A1	GND	B12	GND
A4	VBUS	B9	VBUS
A5	CC1	B8	SBU2
A6	Dp1	B7	Dn2
A7	Dn1	B6	Dp2
A8	SBU1	B5	CC2
A9	VBUS	B4	VBUS
A12	GND	B1	GND

$X. \pm 0.50$ $.X \pm 0.30$ $.XX \pm 0.20$ $.XXX \pm$ /	APPD: Henry Sun CHKD: /		TITLE: 		
	DR: Zhangjing				PART NO: W1016H9-X-XX-R
$X. \pm 2.0^{\circ}$ $.X \pm 1.0^{\circ}$	UNITS: mm	SCALE: 1:1	DWG NO: C-W1016H9-X-XX-R		SHEET: 0
	REV:				